

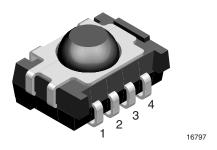
Vishay Semiconductors

RoHS

GREEN

<u>(5-2008)</u>

IR Receiver Modules for Remote Control Systems



FEATURES

- Low supply current
- Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Improved shielding against EMI
- Supply voltage: 2.5 V to 5.5 V
- · Improved immunity against ambient light
- Insensitive to supply voltage ripple and noise
- Taping available for top view and side view assembly
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

MECHANICAL DATA

Pinning

 $1 = GND, 2 = N.C., 3 = V_S, 4 = OUT$

Please see the document "Product Transition Schedule" at www.vishay.com/ir-receiver-modules/ for up-to-date info, when this product will be released.

DESCRIPTION

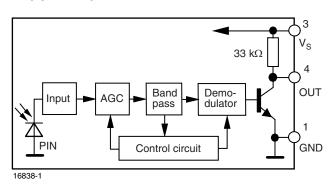
The TSOP61.., TSOP63.. series are miniaturized SMD-IR receivers for infrared remote control systems. A PIN diode and a preamplifier are assembled on a lead frame, the epoxy package acts as an IR filter.

The demodulated output signal can directly be decoded by a microprocessor. The main benefit of the TSOP61.. is the compatibility to all IR remote control data formats. The TSOP63.. is optimized to better suppress spurious pulses from fluorescent lamps and LCD TVs. The TSOP65.. has an excellent noise suppression, it is immune against any dimmed LCD backlighting or plasma TVs. AGC3 and AGC5 may also suppress some data signals in case of continuous transmission.

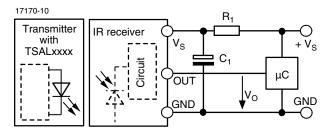
This component has not been qualified according to automotive specifications.

PARTS TABL	E		
CARRIER FREQUENCY	SHORT BURSTS AND HIGH DATA RATES (AGC1)	NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3)	VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5)
30 kHz	TSOP6130	TSOP6330	TSOP6530
33 kHz	TSOP6133	TSOP6333	TSOP6533
36 kHz	TSOP6136	TSOP6336	TSOP6536
38 kHz	TSOP6138	TSOP6338	TSOP6538
40 kHz	TSOP6140	TSOP6340	TSOP6540
56 kHz	TSOP6156	TSOP6356	TSOP6556

BLOCK DIAGRAM



APPLICATION CIRCUIT



The external components R₁ and C₁ are optional to improve the robustness against electrical overstress (typical values are R₁ = 100 Ω , C₁ = 0.1 μ F).

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- 25 to + 85

10

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°C

mW

ABSOLUTE MAXIMUM R	AXIMUM RATINGS			
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		Vs	- 0.3 to + 6	V
Supply current		I _S	5	mA
Output voltage		Vo	- 0.3 to (V _S + 0.3)	V
Output current		I _O	5	mA
Junction temperature		Tj	100	°C
Storage temperature range		Tata	- 25 to + 85	°C

Note

Operating temperature range

Power consumption

• Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

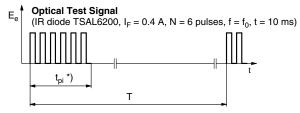
T_{amb} ≤ 85 °C

 T_{amb}

 P_{tot}

ELECTRICAL AND OF	TICAL CHARACTERISTICS	$T_{amb} = 25$	°C, unless	otherwise s	pecified)	
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		Vs	2.5		5.5	V
Cupply ourrent	$V_S = 5 \text{ V}, E_V = 0$	I _{SD}	0.55	0.7	0.9	mA
Supply current	$E_v = 40 \text{ klx, sunlight}$	I _{SH}		0.8		mA
Transmission distance	$E_{\rm V}=0,$ IR diode TSAL6200, $I_{\rm F}=250$ mA, test signal see fig. 1	d		40		m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2,$ test signal see fig. 1	V _{OSL}			100	mV
Minimum irradiance	Pulse width tolerance: t_{pi} - 5/ f_o < t_{po} < t_{pi} + 6/ $f_{o,}$ test signal see fig. 1	E _{e min.}		0.2	0.4	mW/m²
Maximum irradiance	t_{pi} - 5/f _o < t_{po} < t_{pi} + 6/f _o , test signal see fig. 1	E _{e max.}	50			W/m ²
Directivity	Angle of half transmission distance	Ψ1/2		± 50		deg

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



*) $t_{\text{pi}} \ge 6/f_0$ is recommended for optimal function

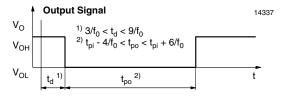


Fig. 1 - Output Active Low

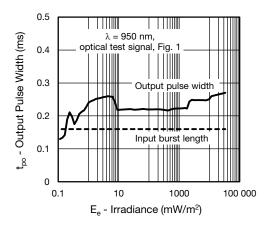


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient



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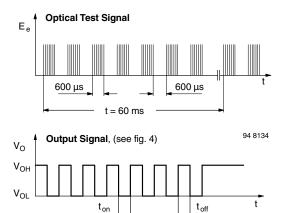


Fig. 3 - Output Function

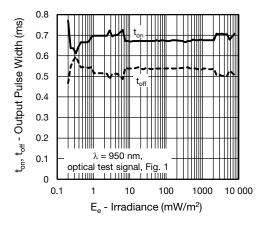


Fig. 4 - Output Pulse Diagram

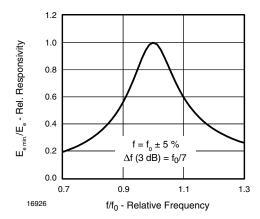


Fig. 5 - Frequency Dependence of Responsivity

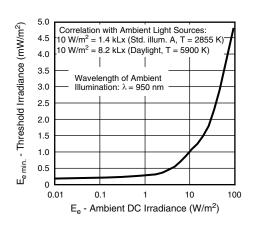


Fig. 6 - Sensitivity in Bright Ambient

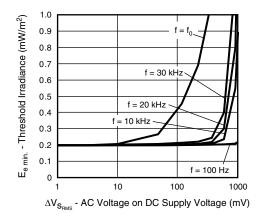


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

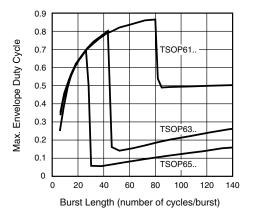


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length



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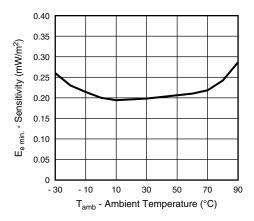


Fig. 9 - Sensitivity vs. Ambient Temperature

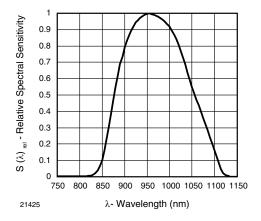


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

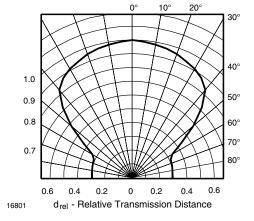


Fig. 11 - Horizontal Directivity

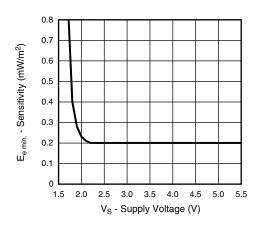


Fig. 12 - Sensitivity vs. Supply Voltage



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SUITABLE DATA FORMAT

These products are designed to suppress spurious output pulses due to noise or disturbance signals. Data and disturbance signals can be distinguished by the devices according to carrier frequency, burst length and envelope duty cycle. The data signal should be close to the band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the IR receiver in the presence of a disturbance signal, the sensitivity of the receiver is reduced to insure that no spurious pulses are present at the output. Some examples of disturbance signals which are suppressed are:

- DC light (e.g. from tungsten bulb or sunlight)
- · Continuous signals at any frequency
- Modulated IR signals from common fluorescent lamps (example of noise pattern is shown in fig. 13 or fig. 14)

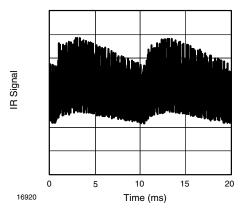


Fig. 13 - IR Signal from Fluorescent Lamp with Low Modulation

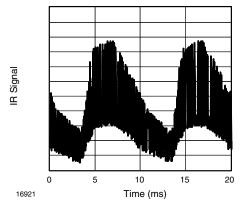


Fig. 14 - IR Signal from Fluorescent Lamp with High Modulation

	TSOP61	TSOP63	TSOP65
Minimum burst length	6 cycles/burst	6 cycles/burst	6 cycles/burst
After each burst of length a minimum gap time is required of	6 to 70 cycles ≥ 10 cycles	6 to 35 cycles ≥ 10 cycles	6 to 24 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	70 cycles > 1.1 x burst length	35 cycles > 6 x burst length	24 cycles > 25 ms
Maximum number of continuous short bursts/second	2000	2000	2000
Recommended for NEC code	yes	yes	yes
Recommended for RC5/RC6 code	yes	yes	yes
Recommended for Sony code	yes	no	no
Recommended for RECS-80 code	yes	yes	yes
Recommended for RCMM code	yes	yes	yes
Recommended for r-step code	yes	yes	yes
Recommended for XMP code	yes	yes	yes
Suppression of interference from fluorescent lamps	Common disturbance signals are supressed (example: signal pattern of fig. 13)	Internference signals from lamps with high modulation are suppressed (examples: signal pattern of fig. 13 and fig. 14)	Even critical disturbance signals like dimmed LCD backlighting are suppressed

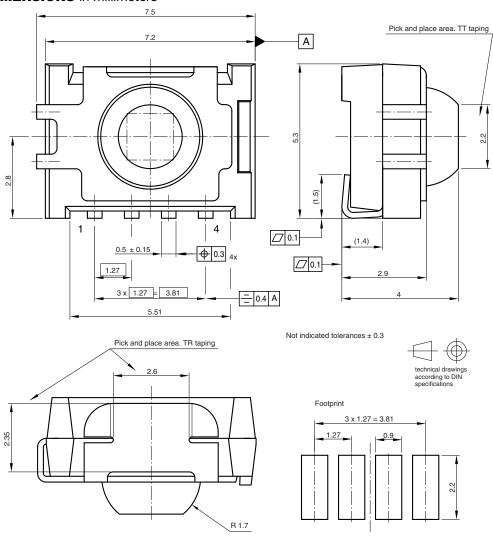
Note

• For data formats with long bursts (10 carrier cycles or longer) we recommend the TSOP62.., TSOP64.. because of the better noise suppression.



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PACKAGE DIMENSIONS in millimeters



Drawing-No.: 6.544-5341.01-4 Issue: 8; 02.09.09

ASSEMBLY INSTRUCTIONS

Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Excercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

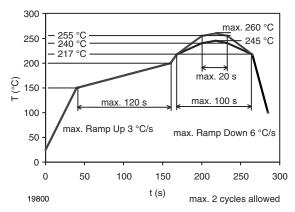
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off



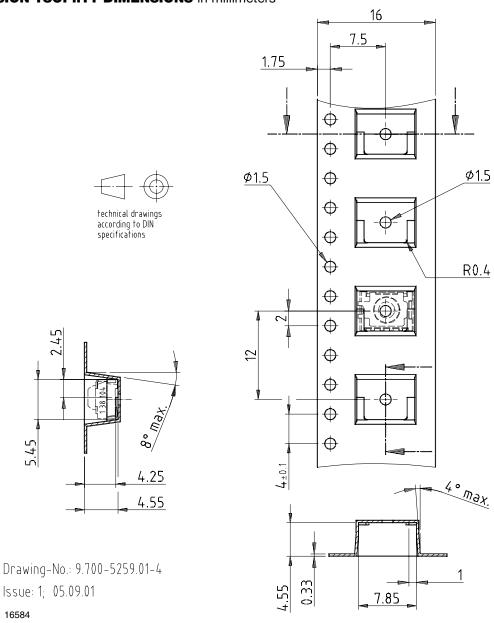


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VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



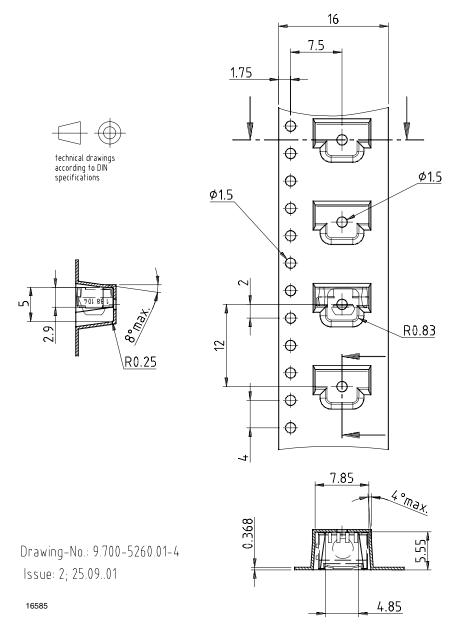
TAPING VERSION TSOP..TT DIMENSIONS in millimeters





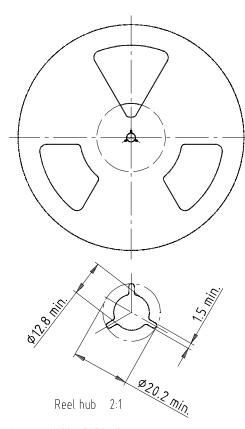
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TAPING VERSION TSOP..TR DIMENSIONS in millimeters



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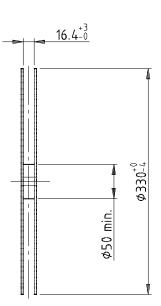
REEL DIMENSIONS in millimeters



Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

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Form of the leave open of the wheel is supplier specific.

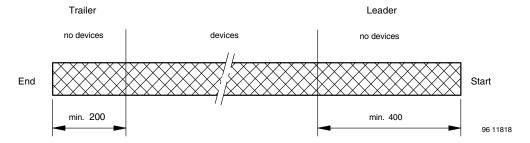
Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

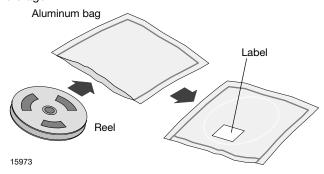


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PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	_	17

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOF OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

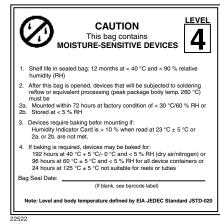
After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 $^{\circ}$ C + 5 $^{\circ}$ C/ - 0 $^{\circ}$ C and < 5 $^{\circ}$ RH (dry air/nitrogen)

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags.



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags



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ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000